AUTOMOTIVE

ROHS

HALOGEN

FREE GREEN

(5-2008)



Vishay Semiconductors

Ambient Light Sensor in 0805 Package



DESCRIPTION

TEMT6200FX01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 0805 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 550 nm.

FEATURES

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- · High photo sensitivity
- · Adapted to human eye responsivity
- Supression filter for near infrared radiation
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



- Automotive sensors
- Ambient light sensor for display backlight dimming in:
 - Mobile phones
 - Notebook computers
 - PDAs
 - Cameras
 - Dashboards

| PRODUCT SUMMARY | | | | | |
|-----------------|-----------------------|---------|-----------------------|--|--|
| COMPONENT | I _{PCE} (μΑ) | φ (deg) | λ _{0.5} (nm) | | |
| TEMT6200FX01 | 23 | ± 60 | 450 to 610 | | |

Note

• Test condition see table "Basic Characteristics"

| ORDERING INFORMATION | | | | | |
|----------------------|---------------------------------|--|------|--|--|
| ORDERING CODE | DRDERING CODE PACKAGING REMARKS | | | | |
| TEMT6200FX01 | Tape and reel | MOQ: 3000 pcs, 3000 pcs/reel. Label with I _{PCE} group on each reel. Specifications of group A/B/C see table "Type Dedicated Characteristics" | 0805 | | |

Note

· MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|--|------------------|-------------|------|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | | |
| Collector emitter voltage | | V_{CEO} | 6 | V | | |
| Emitter collector voltage | | V_{ECO} | 1.5 | V | | |
| Collector current | | Ic | 20 | mA | | |
| Power dissipation | | P_V | 100 | mW | | |
| Junction temperature | | Tj | 100 | °C | | |
| Operating temperature range | | T _{amb} | -40 to +100 | °C | | |
| Storage temperature range | | T _{stg} | -40 to +100 | °C | | |
| Soldering temperature | Acc. reflow profile fig. 9 | T _{sd} | 260 | °C | | |
| Thermal resistance junction/ambient | Soldered on PCB with pad dimensions: 4 mm x 4 mm | R_{thJA} | 450 | K/W | | |



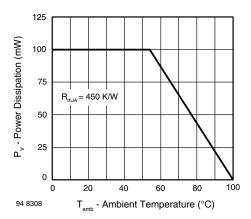


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|---|--------------------|------|------------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Collector emitter breakdown voltage | I _C = 0.1 mA | V_{CEO} | 6 | | | V |
| Collector dark current | V _{CE} = 5 V, E = 0 lx | I _{CEO} | | 3 | 50 | nA |
| Collector emitter capacitance | $V_{CE} = 0 \text{ V, } f = 1 \text{ MHz, } E = 0 \text{ Ix}$ | C _{CEO} | | 16 | | pF |
| Photo current | $E_V = 20 Ix$, CIE illuminant A, $V_{CE} = 5 V$ | I _{PCE} | | 4.6 | | μΑ |
| Prioto current | $E_V = 100 \text{ lx}$, CIE illuminant A, $V_{CE} = 5 \text{ V}$ | I _{PCE} | 7.5 | 23 | 39 | μA |
| Temperature coefficient of I _{PCF} | CIE illuminant A | TK _{IPCE} | | 1.18 | | %/K |
| remperature coefficient of I _{PCE} | LED, white | TK _{IPCE} | | 0.9 | 39 | %/K |
| Angle of half sensitivity | | φ | | ± 60 | | deg |
| Wavelength of peak sensitivity | | λ_{p} | | 550 | | nm |
| Range of spectral bandwidth | | λ _{0.5} | | 450 to 610 | | nm |
| Collector emitter saturation voltage | $E_V = 20 \text{ lx}, 0.45 \mu\text{A}$ | V _{CEsat} | | 0.1 | | V |

| TYPE DEDICATED CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|---|-----------------|------------------|------|------|------|
| PARAMETER | TEST CONDITION | BINNED GROUP | SYMBOL | MIN. | MAX. | UNIT |
| Photo current | $E_V = 100 \text{ lx},$ CIE illuminant A, V_{CE} tz51 = 5 V | Α | I _{PCE} | 7.5 | 15 | μΑ |
| | | В | I _{PCE} | 12 | 24 | μΑ |
| | | С | I _{PCE} | 19.5 | 39 | μΑ |

Note

Each 3000 piece packing unit will contain a single group. The label on the bag will indicate which binned group is in the bag. A specific group
cannot be ordered. Production shipments containing multiple bags will likely include multiple groups. Please design accordingly.

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

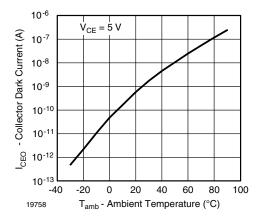


Fig. 2 - Collector Dark Current vs. Ambient Temperature

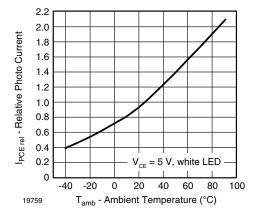


Fig. 3 - Relative Photo Current vs. Ambient Temperature

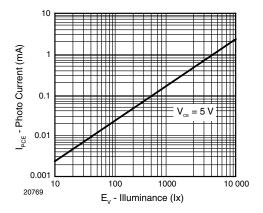


Fig. 4 - Photo Current vs. Illuminance

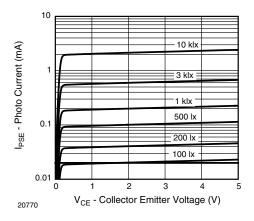


Fig. 5 - Photo Current vs. Collector Emitter Voltage

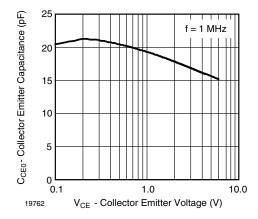


Fig. 6 - Collector Emitter Capacitance vs. Collector Emitter Voltage

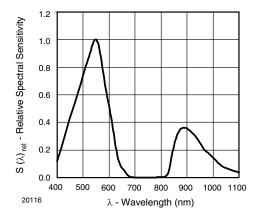


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

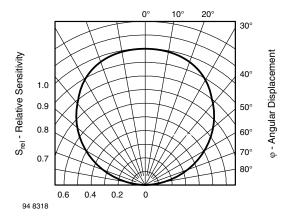


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement

REFLOW SOLDER PROFILE

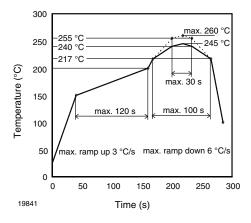


Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

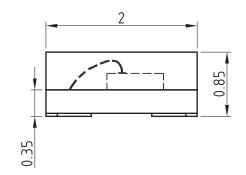
Conditions: T_{amb} < 30 °C, RH < 60 %

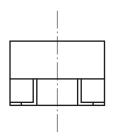
DRYING

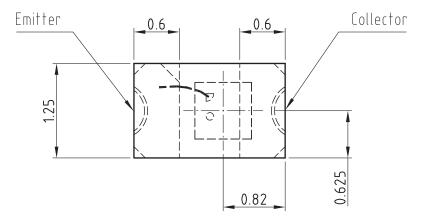
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



PACKAGE DIMENSIONS in millimeters

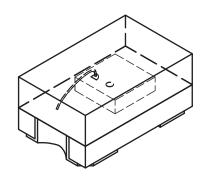




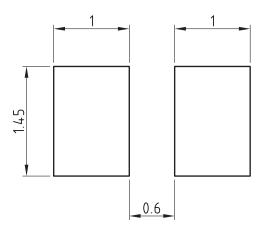




Not indicated tolerances ±0.1



Recommended solder pad Footprint

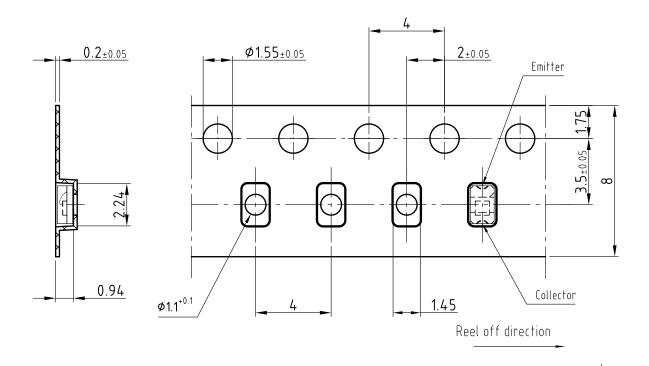


Drawing-No.: 6.541-5063.01-4

Issue: 3; 23.02.07

19757

BLISTER TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5310.01-4

Issue: 2; 14.08.07

20690

Not indicated tolerances ±0.1

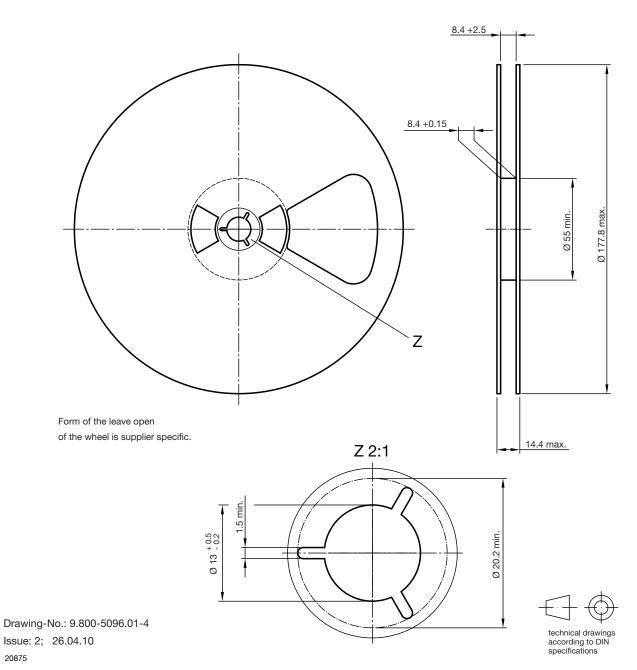
Quantity per reel: 3000 pcs

technical drawings according to DIN specifications

20875

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REEL DIMENSIONS in millimeters





Legal Disclaimer Notice

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